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Substitute for form 1449A/PTO INFORMATION DISCLOSURE	Complete if Known	-021
STATEMENT BY APPLICANT	Application Number	Unknown 10165619
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	First Nam d Inventor	Ahn, Kie
	Group Art Unit	Unknown
	Examiner Name	Unknown
Sheet 1 of 3	Attorney Docket No: 1	1303.033US2

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	First Named Inventor	Ahn, Kie			
	Group Art Unit	Unknown			
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(Use as many sheets as necessary)	Filing Date	Even Date Herewith
	First Named Inventor	Ahn, Kie
	Group Art Unit	Unknown
	Examiner Name	Unknown
Sheet 3 of 3	Attorney Docket No: 1	303.033US2

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